

DOCKET NO.: TALW-0180
Application No.: 09/805,841
Office Action Dated: May 5, 2003

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PATENT
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PROCEDURE PURSUANT TO
37 CFR § 1.116



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Toshiki Inoue, et al.

Confirmation No.: 3801

Application No.: 09/805,841

Group Art Unit: 1742

Filing Date: **March 14, 2001**

Examiner: **Nicolas, Wesley A.**

For: **Electrolytic Plating Method and Device for a Wiring Board**

EXPRESS MAIL LABEL NO: EL969190771 US
DATE OF DEPOSIT: October 6, 2003

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

REPLY PURSUANT TO 37 CFR § 1.116

In response to the Official Action dated **May 5, 2003**, as well as the Advisory Action dated September 15, 2003, reconsideration is respectfully requested in view of the amendments and/or remarks as indicated below. Also filed herewith is a Request for Continued Examination, petition for an extension of time for two (2) months through October 6, 2003, an Information Disclosure Statement, and the appropriate fees.

- ☒ **Amendments to the Specification** begin on page 2 of this paper.
- ☒ **Amendments to the Claims** are reflected in the listing of the claims which begins on page 3 of this paper.
- ☐ **Amendments to the Drawings** begin on page of this paper and include an attached replacement sheet.
- ☒ **Remarks/Arguments** begin on page 7 of this paper.

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